DM1612X560R-10

UNCONTROLLED **DOCUMENT**

PHYSICAL DIMENSIONS:

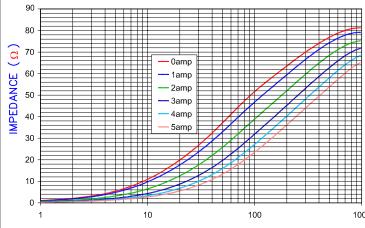
A 4.06 [.160] ± 0.20 [.008]

B 3.05 [.120] ± 0.20 [.008]

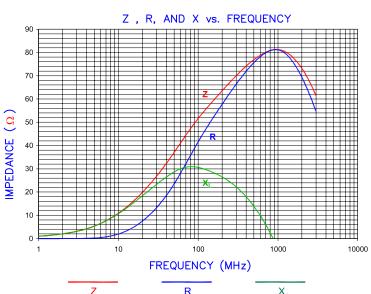
C 2.28 [.090] ± 0.20 [.008]

± 0.25 [.010] D 0.70 [.028]

Z vs FREQUENCY IMPEDANCE UNDER DC BIAS

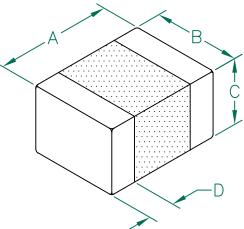


FREQUENCY (MHz)



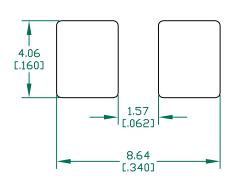
AGILENT E4991A RF Impedance/Material Analyzer

HP 16194A Test Fixture. TEST REF. 3236





LAND PATTERNS FOR REFLOW SOLDERING



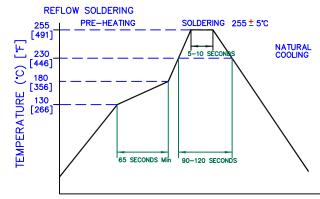
(For wave soldering, add 0.762 [.030] to this dimension.)

ELECTRICAL CHARACTERISTICS:											
Z @ 100MHz (Ω)		DCR $\left(\begin{array}{c}\Omega\end{array}\right)$	Rated Current								
Nominal	56										
Minimum	42										
Maximum	70	0.004	10,000 mA								

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 13" REELS, 2,500 PCS/REEL.
- 2. TERMINATION FINISH IS 100% TIN.
- 3. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 4. OPERATING TEMPERATURE TEMP: -40°C~+125°C (INCLUDING SELF-HEATING)

RECOMMENDED SOLDERING CONDITIONS



2 of 2



DIMENSIONS ARE IN mm [INCHES].			This print is the property of Laird						
				Tech, and is loaned in confidence subject to return upon request and					
				with the understanding that no			Laī		
G	OPERATING TEMPERATURE UPDATE LAIRD LOGO AND REFLOW CURVE	08/05/13	QU	copies shall be made without the written consent of Laird Tech. Al rights to design or invention are	ı .	_	u	11 4	4
F	UPDATE D DIMENSION	03/12/10		reserved.					
E	UPDATE COMPANY LOGO	05/22/09	JRK	DJECT/PART NUMBER:		v	PART TYPE:		DRA
О	UPDATE COMPANY LOGO	1/11/08	JRK	DM1612X560R-10		G	CO-	FIRE	.
С	CHG TOLS ON D DIMENSION	08/28/06	JRK			0	00-	FIRE	
В	CHANGE D DIMENSION & TOLERANCE	03/21/06	JRK		CALE:	N.	75	SHEET:	
Α	ORIGINAL DRAFT	04/02/04	ТМВ	CAD 4	OOL 4		-	2 (of
REV	DESCRIPTION	DATE	INT	DM1612X560R-10-G		~ * -		_ `	٠.